

August 2014

## FDMA291P

# Single P-Channel 1.8V Specified PowerTrench® MOSFET

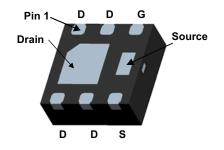
### **General Description**

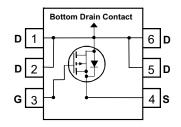
This device is designed specifically for battery charge or load switching in cellular handset and other ultraportable applications. It features a MOSFET with low on-state resistance.

The MicroFET 2x2 package offers exceptional thermal performance for its physical size and is well suited to linear mode applications.

#### **Features**

- -6.6 A, -20V.  $r_{DS(ON)} = 42 \text{ m}\Omega$  @  $V_{GS} = -4.5V$   $r_{DS(ON)} = 58 \text{ m}\Omega$  @  $V_{GS} = -2.5V$   $r_{DS(ON)} = 98 \text{ m}\Omega$  @  $V_{GS} = -1.8V$
- Low profile 0.8 mm maximum in the new package MicroFET 2x2 mm
- Free from halogenated compounds and antimony oxides
- RoHS Compliant





MicroFET 2x2

Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

TA 20 0 difficult flocks				
Symbol	l Parameter		Ratings	Units
V <sub>DS</sub>	Drain-Source Voltage		-20	V
V <sub>GS</sub>	Gate-Source Voltage		±8	V
1	Drain Current - Continuous	(Note 1a)	-6.6	А
I <sub>D</sub>	– Pulsed		-24	
П	Power Dissipation for Single Operation	(Note 1a)	2.4	W
$P_D$		(Note 1b)	0.9	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

### **Thermal Characteristics**

R <sub>eJC</sub>	Thermal Resistance, Junction-to-Case		13	
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	52	°C/W
R <sub>e,IA</sub>	Thermal Resistance, Junction-to-Ambient	(Note 1b)	145	

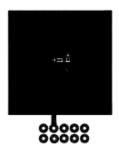
**Package Marking and Ordering Information** 

Device Marking	Device	Reel Size	Tape width	Quantity
291	FDMA291P	7"	8mm	3000 units

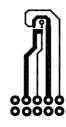
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics				ı	ı
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, \qquad I_{D} = -250 \mu\text{A}$	-20			V
ΔBV <sub>DSS</sub> ΔΤ <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = -250 $\mu$ A, Referenced to 25°C		-12		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 \text{ V},  V_{GS} = 0 \text{ V}$			-1	μΑ
GSS	Gate-Body Leakage	$V_{GS} = \pm 8 \text{ V},  V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_{D} = -250 \mu A$	-0.4	-0.7	-1.0	V
ΔV <sub>GS(th)</sub> ΔT <sub>J</sub>	Gate Threshold Voltage Temperature Coefficient	$I_D$ = -250 $\mu$ A, Referenced to 25°C		3		mV/°C
DS(on)	Static Drain–Source On–Resistance	$V_{GS} = -4.5 \text{ V},  I_D = -6.6 \text{ A}$ $V_{GS} = -2.5 \text{ V},  I_D = -5.1 \text{ A}$ $V_{GS} = -1.8 \text{ V},  I_D = -3.9 \text{ A}$ $V_{GS} = -4.5 \text{ V},  I_D = -6.6 \text{ A},  T_J = 125 ^{\circ}\text{C}$		36 51 79 49	42 58 98 64	mΩ
g <sub>FS</sub>	Forward Transconductance	$V_{DS} = -5 \text{ V}, \qquad I_{D} = -6.6 \text{ A}$		16		S
Dvnamic	Characteristics					
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 \text{ V}.  V_{GS} = 0 \text{ V}.$		1000		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz		190		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	1		100		pF
Switchin	g Characteristics (Note 2)					
t <sub>d(on)</sub>	Turn–On Delay Time	$V_{DD} = -10 \text{ V},  I_{D} = -1 \text{ A},$		13	23	ns
r	Turn-On Rise Time	$V_{GS} = -4.5 \text{ V},  R_{GEN} = 6 \Omega$		9	18	ns
d(off)	Turn-Off Delay Time	1		42	68	ns
f	Turn-Off Fall Time	1		25	40	ns
$\overline{Q_{g}}$	Total Gate Charge	$V_{DS} = -10 \text{ V},  I_{D} = -6.6 \text{ A},$		10	14	nC
$Q_{gs}$	Gate-Source Charge	V <sub>GS</sub> = -4.5 V		2		nC
$Q_{gd}$	Gate-Drain Charge	1		3		nC
Drain–So	ource Diode Characteristics	and Maximum Ratings	•	•		
ls	Maximum Continuous Drain-Source	<u> </u>			-2	Α
V <sub>SD</sub>	Drain–Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = -2 \text{ A}$ (Note 2)		-0.8	-1.2	V
t <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = -6.6 A,		20		ns
Q <sub>rr</sub>	Diode Reverse Recovery Charge	$dI_F/dt = 100 A/\mu s$		8		nC

#### Notes

<sup>1.</sup> R<sub>0JA</sub> is determined with the device mounted on a 1 in<sup>2</sup> oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R<sub>0JC</sub> is guaranteed by design while R<sub>0JA</sub> is determined by the user's board design.



a. 52 °C/W when mounted on a 1 in² pad of 2 oz copper.



b. 145 °C/W when mounted on a minimum pad of 2 oz copper.

## **Typical Characteristics**

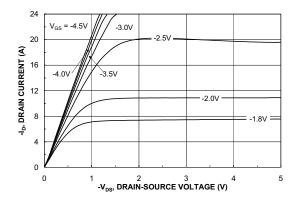


Figure 1. On-Region Characteristics.

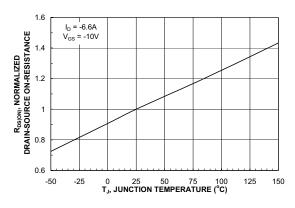


Figure 3. On-Resistance Variation with Temperature.

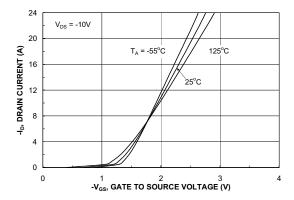


Figure 5. Transfer Characteristics.

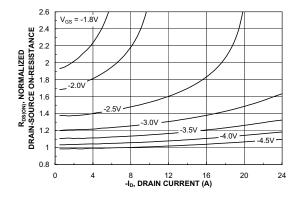


Figure 2. On-Resistance Variation with Drain Current and Gate Voltage.

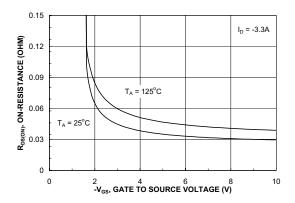


Figure 4. On-Resistance Variation with Gate-to-Source Voltage.

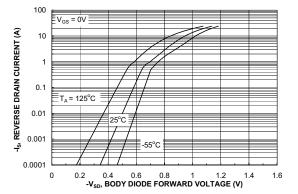
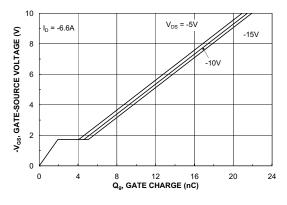


Figure 6. Body Diode Forward Voltage Variation with Source Current and Temperature.

f = 1MHz

V<sub>GS</sub> = 0 V

## **Typical Characteristics**



0 400 Crss 12 16
-V<sub>DS</sub>, DRAIN TO SOURCE VOLTAGE (V)

1600

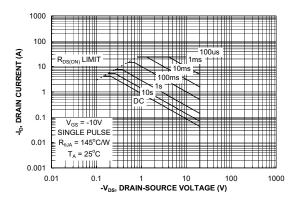
1200

800

CAPACITANCE (pF)

Figure 7. Gate Charge Characteristics.





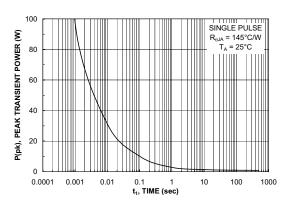


Figure 9. Maximum Safe Operating Area.

Figure 10. Single Pulse Maximum Power Dissipation.

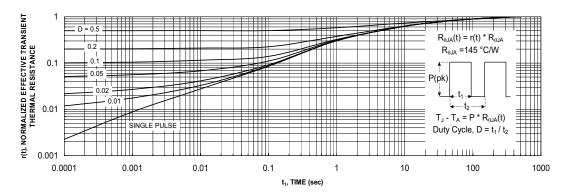
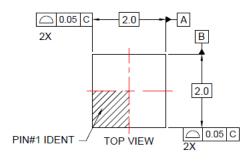
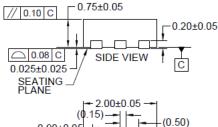


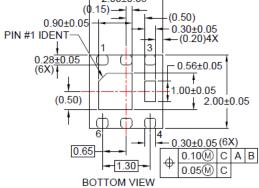
Figure 11. Transient Thermal Response Curve.

Thermal characterization performed using the conditions described in Note 1b. Transient thermal response will change depending on the circuit board design.

### **Dimensional Outline and Pad Layout**

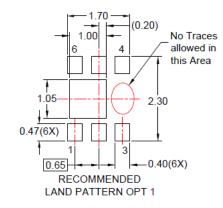


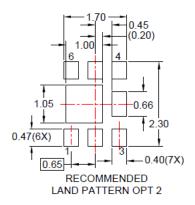




#### NOTES:

- A. PACKAGE DOES NOT FULLY CONFORM TO JEDEC MO-229 REGISTRATION
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 2009.
- LAND PATTERN RECOMMENDATION IS EXISTING INDUSTRY LAND PATTERN.
- E. DRAWING FILENAME: MKT-MLP06Lrev4.







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